

# High Speed PWM Controller

### **FEATURES**

- "Bold Type" Denotes improved or new features
- Improved versions of the UC3823/UC3825 PWMs
- Compatible with Voltage or Current-Mode Topologies
- Practical Operation at Switching Frequencies to 1MHz
- 50ns Propagation Delay to Output
- High Current Dual Totem Pole Outputs (2A Peak)
- Wide Bandwidth Error Amplifier
- Trimmed Oscillator Discharge Current for Accurate Frequency & Dead Time Control
- Fully Latched Logic with Double Pulse Suppression
- Soft Start Control
- Pulse by Pulse Current Limiting Comparator
- Latched Overcurrent Comparator With Full Cycle Restart
- Low StartUp Current 100µA typ.
- Under Voltage Lock Out 16V/10V On & Off ("B" versions)
- Outputs Active Low During UVLO
- Trimmed Bandgap Reference
- Adjustable Blanking For Leading Edge Noise Tolerance

### **DESCRIPTION**

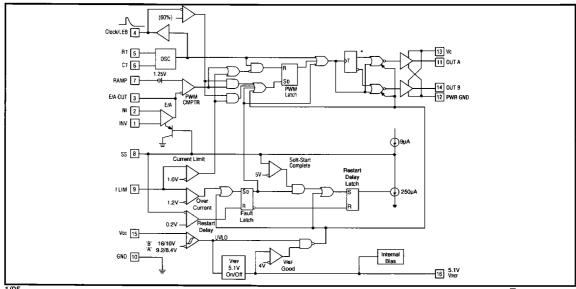
The UC3823A & B and the UC3825A & B family of PWM control ICs are improved versions of the standard UC3823 & UC3825 family. Performance enhancements have been made to several of the circuit blocks. Error amplifier gain bandwidth product is 12MHz while input offset voltage is 2mV. Current limit threshold is guaranteed to a tolerance of 5%. Oscillator discharge current is specified at 10 mA for accurate dead time control. Frequency accuracy is improved to 6%. Start up supply current, typically 100µA, is ideal for off-line applications. The output drivers are redesigned to actively sink current during UVLO at no expense to the start up current specification. In addition each output is capable of 2A peak currents during transitions.

Functional improvements have also been implemented in this family. The UC3825 shutdown comparator is now a high-speed overcurrent comparator with a threshold of 1.2V. The overcurrent comparator sets a latch that ensures full discharge of the soft start capacitor before allowing a restart. While the fault latch is set, the outputs are in the low state. In the event of continuous faults, the soft start capacitor is fully charged before discharge to insure that the fault frequency does not exceed the designed soft start period. The UC3825 Clock pin has become Clk/LEB. This pin combines the functions of clock output and leading edge blanking adjustment and has been buffered for easier interfacing.

The UC3825A,B has dual alternating outputs and the same pin configuration of the UC3825. The UC3823A,B outputs operate in phase with duty cycles from zero to less than 100%. The pin configuration of the '23A,B is the same as the UC3823 except pin 11 is now an output pin instead of the reference pin to the current limit comparator. "A" version parts have UVLO thresholds identical to the original UC3823/25. The "B" versions have UVLO thresholds of 16 and 10V, intended for ease of use in off-line applications.

Consult Application Note U-128 for detailed technical and applications information. Contact the factory for further packaging and availability information.

Device	UVLO (V)	D(MAX)
UC3823A	9.2/8.4	< 100%
UC3823B	16/10	< 100%
UC3825A	9.2/8.4	< 50%
UC3825B	16/10	< 50%



1/95

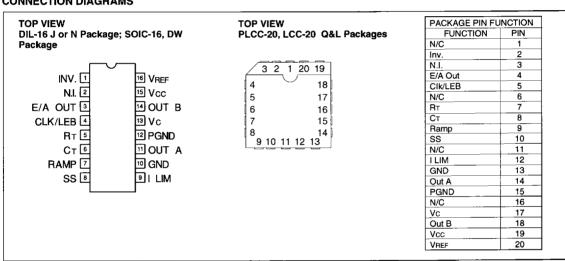
\* Note: 1823A,B Version Toggles Q and Q are always low

Supply Voltage (Pins 15, 13)	22V
Output Current, Source or Sink (Pins 11-14)	
DC	0.5A
Pulse (0.5µs)	2.2A
Power Ground (Pin 12)	+/-0.2V
Analog Inputs	
(Pins 1,2,7)	0.3V to 7V
(Pin 9, 8)	0.3V to 6V
Clock Output Current (Pin 4)	5mA
Error Amplifier Output Current (Pin 3)	5mA

Soft Start Sink Current (Pin 8)	20mA
Oscillator Charging Current (Pin 5)	
Power Dissipation at Ta=60°C	
Storage Temperature Range	
Lead Temperature (Soldering 10 seconds)	

Note: All voltages are with respect to ground Pin 10
Currents are positive into the specified terminal.
Consult packaging section of Databook for thermal limitations and considerations of package.

### **CONNECTION DIAGRAMS**



Electrical Characteristics: Unless otherwise specified, these specifications apply for RT = 3.65k, CT = 1nF, Vcc = 12V, and -55° <TA<125°C for the UC18xxX, -40° <TA<85°C for the UC28xxX, 0° <TA<70°C for the UC38xxX. TJ=TA.

PARAMETER	TEST CONDITION	MIN	TYPE	MAX	UNITS
REFERENCE SECTION					
Output Voltage	T <sub>J</sub> = 25°C, lo = 1mA	5.05	5.1	5.15	V
Line Regulation	12 <vcc<20v< td=""><td></td><td>2</td><td>15</td><td>mV</td></vcc<20v<>		2	15	mV
Load Regulation	1 <lo<10ma< td=""><td></td><td>5</td><td>20</td><td>mV</td></lo<10ma<>		5	20	mV
Total Output Variation	Line, Load, Temp	5.03		5.17	V
Temperature Stability	TMIN <ta<tmax, (note="" 1)<="" td=""><td></td><td>0.2</td><td>0.4</td><td>mV/°C</td></ta<tmax,>		0.2	0.4	mV/°C
Output Noise Voltage	10Hz <f<10khz, (note="" 1)<="" td=""><td></td><td>50</td><td></td><td>μVRMS</td></f<10khz,>		50		μVRMS
Long Term Stability	T <sub>J</sub> = 125°C, 1000 hours, (Note 1)		5	25	mV
Short Circuit Current	VREF = 0V	30	60	90	mA
OSCILLATOR SECTION					
Initial Accuracy	T <sub>J</sub> = 25°C, (Note 1)	375	400	425	kHz
Total Variation	Line, Temp, (Note 1)	350		450	kHz
Voltage Stability	12 <vcc<20v< td=""><td></td><td></td><td>1</td><td>%</td></vcc<20v<>			1	%
Temperature Stability	TMIN <ta<tmax, (note="" 1)<="" td=""><td></td><td>5</td><td></td><td>%</td></ta<tmax,>		5		%
Initial Accuracy	RT = 6.6k, CT = 220pF, Ta = 25°C, (Note 1)	0.9	1	1.1	MHz
Total Variation	RT = 6.6k, CT = 220pF, (Note 1)	0.85		1.15	MHz

Electrical Characteristics (Continued) Unless otherwise specified, these specifications apply for R<sub>T</sub> = 3.65k, C<sub>T</sub> = 1nF, Vcc = 12V, and -55° < Ta<125°C for the UC18xxX, -40° < Ta<85°C for the UC28xxX, 0° < Ta<70°C for the UC38xxX. T<sub>J</sub>=Ta,

PARAMETER	TEST CONDITION	MIN	TYPE	MAX	UNITS
OSCILLATOR SECTION (CONTINUED)					
Clock Out High		3.7	4		V
Clock Out Low			0	0.2	V
Ramp Peak		2.6	2.8	3	٧
Ramp Valley		0.7	1	1.25	V
Ramp Valley to Peak		1.6	1.8	2	V
Osc Discharge Current	RT = open, V(CT) ≠ 2V	9	10	11	mA
ERROR AMPLIFIER SECTION					
Input Offset Voltage			2	10	mV
Input Bias Current			0.6	3	μA
Input Offset Current			0.1	1	μA
Open Loop Gain	1 <vo<4v< td=""><td>60</td><td>95</td><td></td><td>dB</td></vo<4v<>	60	95		dB
CMRR	1.5 <vcm<5.5v< td=""><td>75</td><td>95</td><td></td><td>dB</td></vcm<5.5v<>	75	95		dB
PSRR	12 <vcc<20v< td=""><td>85</td><td>110</td><td>_</td><td>dB</td></vcc<20v<>	85	110	_	dB
Output Sink Current	Vpin3 = 1V	1	2.5		mA
Output Source Current	Vpin3 = 4V	-0.5	-1.3		mA
Output High Voltage	I pin3 = -0.5mA	4.5	4.7	5	V
Output Low Voltage	I pin3 = 1mA	0	0.5	1	٧
Gain Bandwidth Product	F = 200KHz	6	12		MHz
Slew Rate	(Note 1)	6	9		V/µs
PWM COMPARATOR SECTION					
Pin 7 Bias current	Vpin7 = 0V		-1	-8	μA
Minimum Duty Cycle				0	%
Maximum Duty Cycle		85			%
Leading Edge Blanking	R = 2k, C = 470pF	300	375	450	ns
LEB Resistor	Vpin4 = 3V	8.5	10	11.5	kohm
Pin 3 Zero D.C. Threshold	Vpin7 = 0V	1.1	1.25	1.4	V
Delay to Output *	Vpin3 = 2.1V, Vpin7 = 0 to 2V step, (Note 1)		50	80	ns
CURRENT LIMIT / START SEQUENCE / FA	ULT SECTION	•		_	
Soft Start Charge Current	Vpin8 = 2.5V	8	14	20	μΑ
Full Soft Start Threshold		4.3	5		٧
Restart Discharge Current	Vpin8 = 2.5V	100	250	350	μА
Restart Threshold			0.3	0.5	V
Pin 9 Bias Current	0 <vpin9<2v< td=""><td></td><td></td><td>15</td><td>μΑ</td></vpin9<2v<>			15	μΑ
Current Limit Threshold		0.95	1	1.05	٧
Over Current Threshold		1.14	1.2	1.26	٧
I LIM Delay to Output	Vpin9 = 0 to 2V step, (Note 1)		50	80	ns
OUTPUT SECTION					
Output Low Saturation	IOUT = 20mA		0.25	0.4	٧
	Iout = 200mA		1.2	2.2	٧
Output High Saturation	Iout = 20mA		1.9	2.9	V
	10ur = 200mA		2	3	V
UVLO Output Low Saturation	Io = 20mA		0.8	1.2	V
Rise/Fall Time	CL = 1nF, (Note 1)		20	45	ns

Electrical Characteristics (Continued): Unless otherwise specified, these specifications apply for RT = 3.65k, CT = 1nF, Vcc = 12V, and -55° < TA<125°C for the UC18xxX, -40° < TA<85°C for the UC28xxX, 0° < TA<70°C for the UC38xxX. TJ=TA.

PARAMETER	TEST CONDITIONS	MIN	TYPE	MAX	UNITS
UNDER VOLTAGE LOCKOUT					
Start Threshold	UCX823B and X825B only		16	17	V
Stop Threshold	UCX823B and X825B only	9	10		V
UVLO Hysteresis	UCX823B and X825B only	5	6	7	V
Start Threshold	UCX823A and X825A only	8.4	9.2	9.6	V
UVLO Hysteresis	UCX823A and X825A only	0.4	0.8	1.2	٧
SUPPLY CURRENT				_	
Start Up Current	Vc = Vcc = Vth(start) - 0.5V		100	300	μΑ
Icc			28	36	mA

Note 1: This parameter is guaranteed by design but not 100% tested in production.

### **APPLICATIONS INFORMATION**

## OSCILLATOR

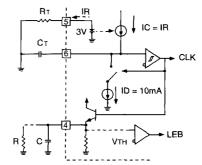
The 3823A,B/3825A,B oscillator is a saw tooth. The rising edge is governed by a current controlled by the RT pin and value of capacitance at the CT pin. The falling edge of the sawtooth sets dead time for the outputs. Selection of RT should be done first, based on desired maximum duty cycle. CT can then be chosen based on desired frequency, RT, and DMAX. The design Equations are:

$$RT = \frac{3V}{(10\text{mA})(1 - \text{DMAX})}$$

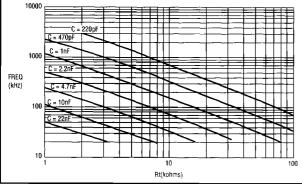
$$CT = \frac{(1.6 \cdot \text{DMAX})}{(RT \cdot F)}$$

Recommended values for RT range from 1K to 100K. Control of DMAX less than 70% is not recommended.

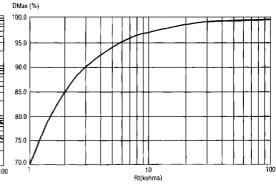
# OSCILLATOR



### OSC. FREQ vs Rt & Ct CURVE



### MAX. DUTY CYCLE vs RT CURVE



### **APPLICATIONS INFORMATION (Continued)**

### LEADING EDGE BLANKING

The UC3823A,B/3825A,B performs fixed frequency pulse width modulation control. The '23A,B outputs operate together at the switching frequency and can vary from 0 to some value less than 100%. The '25A,B outputs are alternately controlled. During every other cycle, one output will be off. Each output then, switches at one-half the oscillator frequency, varying in duty cycle from 0 to less than 50%.

To limit maximum duty cycle, the internal clock pulse blanks both outputs low during the discharge time of the oscillator. On the falling edge of the clock, the appropriate output(s) is driven high. The end of the pulse is controlled by the PWM comparator, current limit comparator, or the overcurrent comparator.

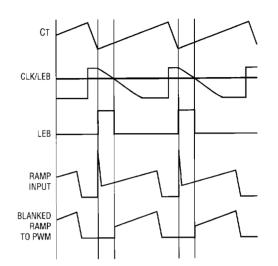
Normally the PWM comparator will sense a ramp crossing a control voltage (error amp output) and terminate the pulse. Leading edge blanking (LEB) causes the PWM comparator to be ignored for a fixed amount of time after the start of the pulse. This allows noise inherent with switched mode power conversion to be rejected. The PWM ramp input may not require any filtering as result of leading edge blanking.

To program a Leading Edge Blanking period, connect a capacitor, C, to Clk/LEB. The discharge time set by C and the internal 10k resistor will determine the blanked interval. The 10k resistor has a 10% tolerance. For more accuracy, an external 2k 1% resistor, R, can be added, resulting in an equivalent resistance of 1.66k with a tolerance of 2.4% The design equation is:

tles = 0.5 •(R ! ! 10k) • C.

Values of R less than 2k should not be used.

### LEB OPERATIONAL WAVEFORMS



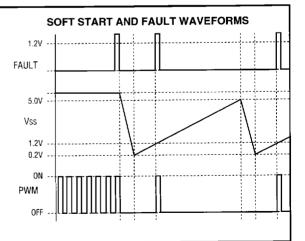
Leading edge blanking is also applied to the current limit comparator. After LEB, if the lum pin exceeds the one volt threshold, the pulse is terminated. The over current comparator, however, is not blanked. It will catch catastrophic over current faults without a blanking delay. Any time the lum pin exceeds 1.2V, the fault latch will be set and the outputs driven low. For this reason, some noise filtering may be required on the lum pin.

### **UVLO, SOFT START AND FAULT MANAGEMENT**

Soft start is programmed by a capacitor on the SS pin. At power up, the SS pin is discharged. When the SS pin is low, the error amp output is also forced low. As the internal 9uA source charges the SS pin, the error amp output follows until closed loop regulation takes over.

Anytime that the ILIM pin exceeds 1.2V, the fault latch will be set and the output pins will be driven low. The soft start cap is then discharged by a 250uA current sink. No more output pulses are allowed until soft start is fully discharged, and the I LIM pin is below 1.2V. At this point the fault latch will be reset and the chip will execute a soft start.

Should the fault latch be set during soft start, the outputs will be immediately terminated, but the soft start cap will not be discharged until it has been fully charged. This results in a controlled hiccup interval for continuous fault conditions.



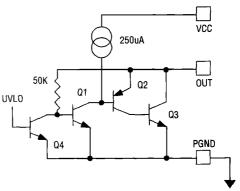
### **APPLICATIONS INFORMATION (Continued)**

### **ACTIVE LOW OUTPUTS DURING UVLO**

The UVLO function forces the outputs to be low and considers both Vcc and Vref before allowing the chip to operate.

# OUTPUT V & I DURING UVLO 3 2 Vout (V) 1 0 0.2 0.4 0.6 0.8 1.0

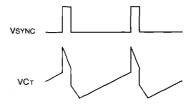
# SIMPLIFIED SCHEMATIC



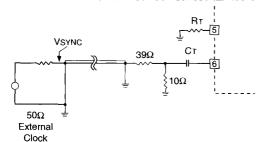
### **SYNCHRONIZATION**

The oscillator can be synchronized by an external pulse inserted in series with the timing capacitor. Program the free running frequency of the oscillator to be 10 to 15% slower than the desired synchronous frequency. The pulse width should be greater than 10ns and less than half the discharge time of the oscillator. The rising edge of the Clk/LEB pin can be used to generate a synchronizing pulse for other chips. Note that, the Clk/LEB pin will no longer accept an incoming synchronizing signal.

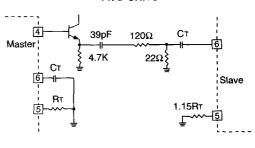
# OPERATIONAL WAVEFORMS



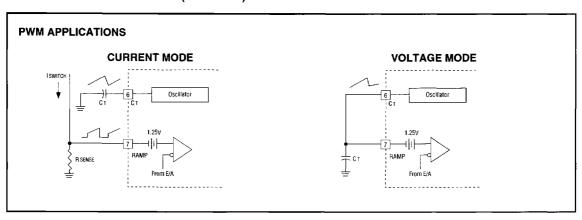
### **GENERAL OSCILLATOR SYNCHRONIZATION**



### TWO UNITS



### **APPLICATIONS INFORMATION (Continued)**

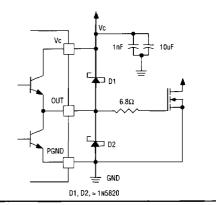


### HIGH CURRENT OUTPUTS

Each totem pole output of the UC3823A,B and UC3825A,B can deliver a 2 amp peak current into a capacitive load. The output can slew a 1000pF capacitor 15 volts in approximately 20 nanoseconds. Separate collector supply (Vc) and power ground (PGND) pins help decouple the ICs analog circuitry from the high power gate drive noise. The use of 3 Amp SCHOTTKY diodes (1N5120, USD245 or equivalent) as shown in the figure from each output to both Vc and PGND are recommended. The diodes clamp the output swing to the supply rails, necessary with any type of inductive/capacitive load, typical of a MOSFET gate. SCHOTTKY diodes must be used because a low forward voltage drop is required. DO NOT USE standard silicon diodes.

Although a "single ended" device, two output drivers are available on the UC3823A,B devices. These can be "paralleled" by the use of a one-half ohm (noninductive) resistor connected in series with each output for a combined peak current of 4 amps.

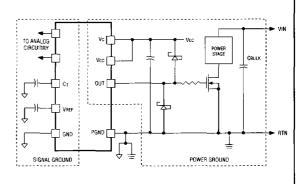
### **POWER MOSFET DRIVE CIRCUIT**



### **GROUND PLANES**

Each output driver of these devices is capable of 2A peak currents. Careful layout is essential for correct operation of the chip. A ground plane must be employed. A unique section of the ground plane must be designated for high dikft currents associated with the output stages. This point is the power ground to which the PGND pin is connected. Power ground can be separated from the rest of the ground plane and connected at a single point, although this is not strictly necessary if the high dikft paths are well understood and accounted for. Vcc should be bypassed directly to power ground with a good high frequency capacitor. The sources of the power MOSFET should connect to power ground as should the return connection for input power to the system and the bulk input capacitor. The output should be camped with a high current Schottky diode to both Vcc and PGND. Nothing else should be connected to power ground.

Vref should be bypassed directly to the signal portion of the ground plane with a good high frequency capacitor. Low ESR/ESL ceramic 1uF capacitors are recommended for both Vcc and VnEF. All analog circuitry should likewise be bypassed to the signal ground plane.



# UC3823A/B, UC3825A/B Clk/LEB VCC 10uF OSCILLATOR OUT A 11 \\ \frac{\}{\} 50 E/A OUT OUT B 14 ERROR AMP NON INV 10K 1N5820 (\*4) PWR GND SOFT START GND

LLIM

**OPEN LOOP TEST CIRCUIT** 

This test fixture is useful for exercising many of the UC3823A,B, UC3825A,B functions and measuring their specifications.

10K

3.3K

As with any wideband circuit, careful grounding and bypass procedures should be followed. The use of a ground plane is highly recommended.

┼ 0.1uF

5.1V